PRODUCT BRIEF Intel® Ethernet Server Adapter X520-DA1/X520-DA2 for Open Compute Project (OCP) Network Connectivity

Intel[®] Ethernet Server Adapter X520-DA1/X520-DA2 for Open Compute Project (OCP)

10 gigabit Ethernet server adapters provide ultimate flexibility and scalability for cloud deployments



Overview

The best-selling Intel® Ethernet Converged Network Adapter X520 Series is known for its high performance, low latency, reliability, and flexibility. The addition of the Intel® Ethernet Server Adapter X520 Series for Open Compute Project (OCP) to the family delivers the X520 capabilities in an Open Compute Project (OCP) form factor.

The Intel® Ethernet Server Adapter X520 Series for Open Compute Project (OCP) delivers a proven, reliable solution for deployments of Ethernet for high bandwidth, low cost, 10GbE network connections. Increased I/O performance with Intel® Data Direct I/O Technology (Intel® DDIO) and support for intelligent offloads make this adapter a perfect match for scaling performance on Intel® Xeon® processor E5/ E7 based servers.

Powered by the Intel® 82599 10 Gigabit Ethernet Controller, the Intel® Ethernet Server Adapter X520 Series for OCP addresses the demanding needs of the next-generation data center by providing unmatched features for virtualization and proven, reliable performance. The Intel® 82599 10 Gigabit Ethernet Controller is the industry standard for 10 GbE, making it the most popular 10GbE controller on the market today.

The Open Compute Project (OCP) is a Facebook* initiative to openly share custom data center designs to improve both cost and energy efficiency across the industry. The OCP uses a minimalist approach to system design thereby reducing complexity and cost, allowing data centers to scale out more effectively. By publishing the designs and specifications of this lowpower, low-cost hardware, it can reduce the cost of infrastructure for businesses large and small.

Optimized for Multi-core Processor Servers

Intel® Ethernet Flow Director

Today's data centers depend on the multiprocessing, high performance capability of servers to increase system throughput, responsiveness, and reliability through the introduction of additional hardware threads, CPUs, or cores. But in a multiprocessing environment, it is essential to ensure a coordinated affinity of protocol processing and network applications on the same target cores. This affinity significantly reduces contention for shared resources, minimizes software synchronization overheads between cores, and enhances cache efficiency.

Receive Side Scaling (RSS) resolves the single-processor bottleneck by enabling the receive side network load from a network adapter to be shared across multiple cores. RSS enables packet receive-processing to scale with the number of available cores. However, RSS has a limitation. it cannot steer an incoming network flow to the same core where the application process resides. RSS does not maintain the Traffic Flow>Core (Application) relationship. If an application is running on one core, while RSS has scheduled receive traffic to be on another core, poor cache efficiency and significant core-to-core synchronization overheads will result. The overall system performance can be significantly degraded.

The Intel® Ethernet Flow Director and the Application Target Routing (ATR) service found in Intel's Ethernet controllers, is an advanced network offload technology that provides the benefits of parallel receive processing in multiprocessing environments that automatically steer incoming network data to the same core on which its application process resides. Intel Ethernet Flow Director and ATR preserve the Traffic Flow>Core (Application) relationship. As a result, Intel Ethernet Flow Director and ATR can significantly lower latency and improve CPU usage.

Intel Ethernet Flow Director enables administrators to define "signature filters" and the ATR service on the Intel Ethernet controller uses these filters to ensure that all packets in a TCP flow are processed by a single core. This intelligent offload capability supports advanced filters that direct receive packets by their flows to different queues and enables tight control on routing a flow in the platform. It matches flows and CPU cores for flow affinity and supports multiple parameters for flexible flow classification and load balancing.

Best Choice for Virtualization

Intel leads the industry in virtualization by being the first to provide virtualization for all the major operating systems and working with the OEMs to implement virtualization not only on the adapter but also on the platform.

Intel[®] Virtualization Technology for connectivity (Intel[®] VT-c)

Intel[®] Ethernet Controllers includes Intel[®] Virtualization Technology for connectivity (Intel VT-c) to deliver virtualized I/O performance optimizations and Quality of Service (QoS) features designed directly in to the controller's silicon. Working in conjunction with virtualization optimized drivers, PCI-SIG* Single Root I/O Virtualization and Sharing (SR-IOV) can be used to help reduce I/O bottlenecks, and improve the overall server performance.

Hypervisor BYPASS using SR-IOV

Bypassing the hypervisor and allowing direct hardware access by virtual machines, reduces CPU overhead, reduces latency, and increases network throughput. Most of the current hypervisor releases have been enabled to partition a single physical Ethernet controller into multiple virtual Ethernet controllers that can be used directly by VMs by taking advantage the PCI-SIG* SR-IOV standard. The use of these virtual controllers, known as Virtual Functions (VF), enables additional QoS features in the controller's silicon to manage and direct traffic such as traffic isolation, port partitioning with bandwidth allocation and on-chip VF-VF switching.

Features	Benefits			
GENERAL				
Intel* 82599 10 Gigabit Ethernet Controller	Industry-leading, energy-efficient design for next-generation 10 Gigabit performance and multi-core processors.			
SFP+ Connectivity	Intel® Ethernet Server Adapter X520 Series for OCP with SFP+ connections support 10GBASE-SR, 10GBASE-LR and SFP+ Copper Direct Attach physical media.			
OCP Form Factor	Supports the OCP form factor for Server specifications revision 2			
iSCSI Remote Boot v3.0	 Enables system boot-up via iSCSI Provides additional network management capability 			
RoHS-compliant	Complies with the European Union directive 2002/95/EC to reduce the use of hazardous materials			
Time Sync (IEEE 1588*, 802.1as)	 Enables networked Ethernet equipment to synchronize internal clocks according to a network mas- ter clock; endpoint can then acquire an accurate estimate of the master time by compensating for link latency. 			
Low Halogen	Leadership in an environmentally friendly ecosystem			
SMBus or NC-SI enabled	Provides out of band (OOB) network access			
I/O FEATURES FOR MULTI-CORE PROCESSOR SE	ERVERS			
Intel® Data Direct I/O (Intel® DDIO)	 Reduces memory accesses from I/O on local socket Speeds up CPU data transfer Accelerates inbound & outbound data flows 			
Intel® Ethernet Flow Director	 Intel Ethernet Flow Director and ATR can significantly lower latency and improve CPU utilization by pre- serving the affinity between the flow and the core where the application resides 			
RSS - Receive Side Scaling	Uses multiple queues for receive traffic			
MSI-X support	 Minimizes the overhead of interrupts Load-balancing of interrupt handling between multiple cores/CPUs 			
Low Latency Interrupts (LLI)	 Based on the sensitivity of the incoming data, the adapter can bypass the automatic moderation of time intervals between the interrupts 			
Multiple Queues: 128 Tx and Rx queues per port	Network packet handling without waiting or buffer overflow providing efficient packet prioritization			
Tx/Rx IP, SCTP, TCP, and UDP checksum offloading (IPv4, IPv6) capabilities	 Lower processor usage Checksum and segmentation capability extended to new standard packet type 			
TxTCP segmentation offload (IPv4, IPv6)	 Increased throughput and lower processor usage 			
Interrupt Throttle Rate (ITR)	 ITR parameter controls how many interrupts each interrupt vector can generate per second. 			
Jumbo frames	 Supports jumbo frames larger then default 1500 			
Large Receive Offload (LRO)	 Combines multiple Ethernet frames into a single receive in the stack, thereby potentially decreasing CPU usage for receives 			
MAC and VLAN anti-spoofing	 If a malicious driver attempts to send a spoofed packet, it is dropped by the hardware and not transmitted. An interrupt is sent to the PF driver notifying it of the spoof attempt. 			
Flow Control	 Ethernet Flow Control (IEEE 802.3x) support for capable link partner 			
HW based receive side coalescing (RSC)	 Merges multiple frames from the same IPv4 TCP/IP flow into a single structure that can span one or more descriptors. 			
Virtualization Features				
PC-SIG SR-IOV Implementation (up to 64 virtual functions per port)	 Provides an implementation of the PCI-SIG standard for I/O Virtualization. The physical configuration of each port is divided into multiple virtual ports. Each virtual port is assigned to an individual virtual machine directly by bypassing the virtual switch in the Hypervisor, resulting in near-native performance. Integrated with Intel® VT for Directed I/O (Intel® VT-d) to provide data protection between virtual ma- 			
	chines by assigning separate physical addresses in the memory to each virtual machine			
Advanced Packet Filtering	 24 exact-matched packets (unicast or multicast) 4096-bit hash filter for unicast and multicast frames Lower processor usage Promiscuous (unicast and multicast) transfer mode support Optional filtering of invalid frames 			
VLAN support with VLAN tag insertion, stripping and packet filtering for up to 4096 VLAN tags	Ability to create multiple VLAN segments			

Manageability Features						
Preboot eXecution Environment (PXE) Support		 Enables system boot up via the LAN (32-bit and 64-bit) Flash interface for PXE image 				
						Simple Network Management Protocol (SNMP) and Remote Network Monitoring (RMON) Statistic Counters
Watchdog Timer		 Gives an indication to the manageability firmware or external devices that the chip or the driver is not functioning 				
Specifications						
General						
Connectors		 One or two LC fiber-optic connectors (NOTE: Intel* Ethernet SFP+ Optics are required if optics will be used) SFP+ Direct Attach cables 				
Network Standards		IEEE 802.3 SFF-8431				
Technical Features						
Data rate supported per port		 Optical: 1 GbE/10 Gb Direct Attach: 10 GbE 				
Bus type		PCI Express 2.0 (5.0	PCI Express 2.0 (5.0 GT/s)			
Bus width		4-lane PCI Express	and 8-lane PCI Express			
Interrupt levels		INTA, MSI, MSI-X				
Hardware certifications		FCC B, UL, CE, VCCI, BSMI, CTICK, KCC				
Controller-processor		Intel® 82599 10 Gigabit Ethernet Controller				
Power Consumption	ower Consumption Single-port		Dual Port			
10GBASE-SR/1000BASE-SX 10GBASE-LR/1000BASE-LX Direct Attached Twinax	Maximum: 8.71W* Typical: 3.9W** Maximum: 8.71W* Typical: 3.9W** Maximum: 5.18W* Typical: 4.1W**	10GBASE-LR M	1aximum: 14.4W* Typical: 4.8W** 1aximum: 14.4W* Typical: 4.8W** 1aximum: 7.4W* Typical: 4.1 W**			
Operating temperature		0 °C to 55 °C (32 °F to 131 °F)				
Air Flow		Minimum of 100 LFM required				
Storage temperature		-40 °C to 70 °C (-40 °F to 158 °F)				
Storage humidity		Maximum: 90% non-condensing relative humidity at 35 °C				
LED Indicators		LINK (solid) and ACTIVITY (blinking) LINK SPEED (green=10 Gbps; yellow=1 Gbps)				
Physical Dimensions		Standard OCP Form Factor				
Network Operating Sys	stem (NOS) Support					
Operating System		IA-32	x86-64			
Windows Server 2008 R2 SP1		N/A	γ			
Windows Server 2012		N/A	γ			
Windows Server 2012 R2		N/A	γ			
Linux* Stable Kernel version 2.6/3.x		Y	γ			
Linux RHEL 5.9		Y	γ			
Linux RHEL 6.4		Y	γ			
Linux SLES 10 SP4		Y	γ			
Linux SLES 11 SP2		Y	γ			
Free BSD 9		Y	γ			
UEFI 2.1/2.3		N/S	γ			

*Calculated max assumes that either SR or LR optics consume 3.15W.

**Average of measurement data taken at nominal voltage and 25 °C temperature

Intel® Ethernet Server Adapter X520 Series for OCP Product Codes		Intel® Ethernet SFP+ Twinaxial Cable Product Codes		Intel® Ethernet SFP+ Optic Product Codes	
Configuration	Product Code	Cable Length (m)	Product Code	Configuration	Product Code
Single Port	X520DA10CP ² X520DA10CPG2P20 ³	1	XDACBL1M	SR Optic	E10GSFPSR
Dual Port	X520DA20CP ² X520DA20CPG2P20 ³	3	XDACBL3M	LR Optic	E10GSFPLR
		5	XDACBL5M		

For product information

To speak to a customer service representative, please call 1-800-538-3373 (U.S. and Canada) or visit support.intel.com/ support/go/network/ contact.htm for the telephone number in your area. For additional product information on Intel Networking Connectivity products, visit www.intel.com/go/ethernet.

Customer Support

Intel[®] Customer Support Services offers a broad selection of programs including phone support and warranty service. For more information, contact us at support. intel.com/support/go/network/ adapter/ home.htm.

(Service and availability may vary by country.)

For more information on the Intel® Ethernet CNA X520-DA10CP, visit www.intel.com/go/ethernet

¹Requires a system supporting VMDq.

- ² SMBus enabled.
- ³ NC-SI enabled.

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